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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	64
Number of Logic Elements/Cells	-
Total RAM Bits	73728
Number of I/O	88
Number of Gates	40000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v40-6fgg256c

Table 6: **Virtex-II Device/Package Combinations and Maximum Number of Available I/Os (Advance Information)**

Package(1,2)	Available I/Os										
	XC2V 40	XC2V 80	XC2V 250	XC2V 500	XC2V 1000	XC2V 1500	XC2V 2000	XC2V 3000	XC2V 4000	XC2V 6000	XC2V 8000
CS144/CSG144	88	92	92	-	-	-	-	-	-	-	-
FG256/FGG256	88	120	172	172	172	-	-	-	-	-	-
FG456/FGG456	-	-	200	264	324	-	-	-	-	-	-
FG676/FGG676	-	-	-	-	-	392	456	484	-	-	-
FF896	-	-	-	-	432	528	624	-	-	-	-
FF1152	-	-	-	-	-	-	-	720	824	824	824
FF1517	-	-	-	-	-	-	-	-	912	1,104	1,108
BG575/BGG575	-	-	-	-	328	392	408	-	-	-	-
BG728/BGG728	-	-	-	-	-	-	-	516	-	-	-
BF957	-	-	-	-	-	-	624	684	684	684	-

Notes:
1. All devices in a particular package are pinout (footprint) compatible. In addition, the FG456/FGG456 and FG676/FGG676 packages are compatible, as are the FF896 and FF1152 packages.
2. Wire-bond packages CS144, FG256, FG456, FG676, BG575, and BG728 are also available in Pb-free versions CSG144, FGG256, FGG456, FGG676, BGG575, and BGG728. See Virtex-II Ordering Examples for details on how to order.

Virtex-II Ordering Examples

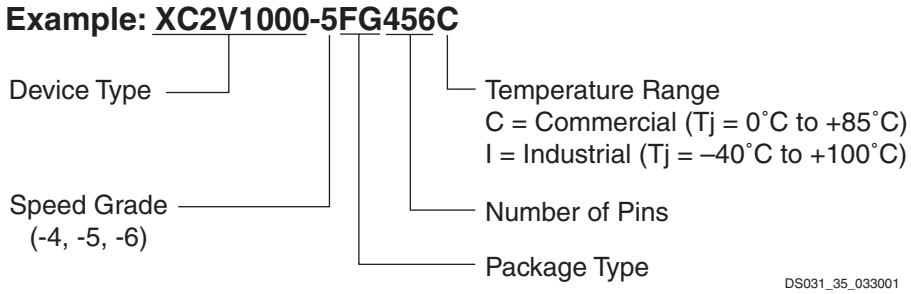

Figure 2: **Virtex-II Ordering Example. Regular Package**

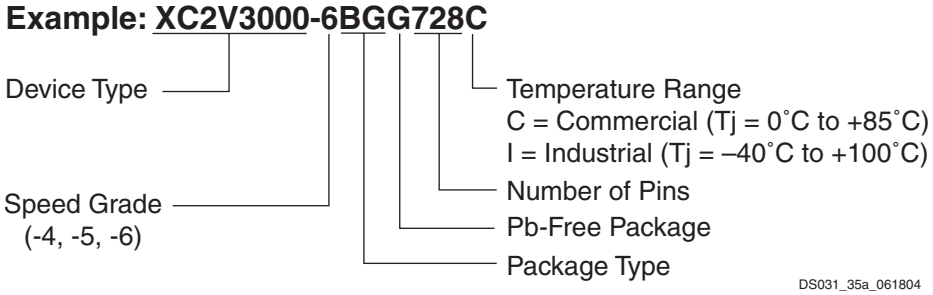

Figure 3: **Virtex-II Ordering Example. Pb-Free Package**

Detailed Description

Input/Output Blocks (IOBs)

Virtex-II™ I/O blocks (IOBs) are provided in groups of two or four on the perimeter of each device. Each IOB can be used as input and/or output for single-ended I/Os. Two IOBs can be used as a differential pair. A differential pair is always connected to the same switch matrix, as shown in Figure 1.

IOB blocks are designed for high performances I/Os, supporting 19 single-ended standards, as well as differential signaling with LVDS, LDT, Bus LVDS, and LVPECL.

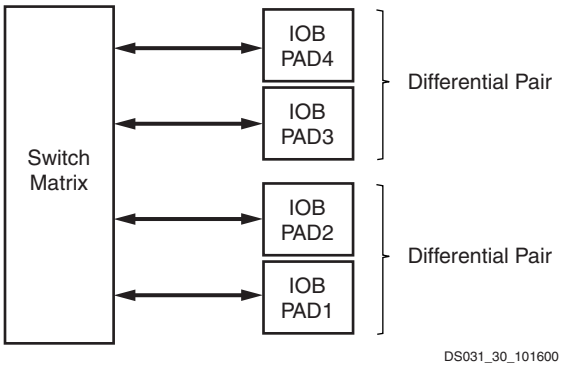

Figure 1: **Virtex-II Input/Output Tile**

Note: Differential I/Os must use the same clock.

Supported I/O Standards

Virtex-II IOB blocks feature SelectI/O-Ultra inputs and outputs that support a wide variety of I/O signaling standards. In addition to the internal supply voltage (V_{CCINT} = 1.5V), output driver supply voltage (V_{CCO}) is dependent on the I/O standard (see Table 1 and Table 2). An auxiliary supply voltage (V_{CCAUX} = 3.3 V) is required, regardless of the I/O standard used. For exact supply voltage absolute maximum ratings, see DC Input and Output Levels in Module 3.

All of the user IOBs have fixed-clamp diodes to V_{CCO} and to ground. As outputs, these IOBs are not compatible or compliant with 5V I/O standards. As inputs, these IOBs are not normally 5V tolerant, but can be used with 5V I/O standards when external current-limiting resistors are used. For more details, see the “5V Tolerant I/Os“ Tech Topic at www.xilinx.com.

Table 3 lists supported I/O standards with Digitally Controlled Impedance. See Digitally Controlled Impedance (DCI), page 8.

Table 1: **Supported Single-Ended I/O Standards**

IOSTANDARD Attribute	Output V_{CCO}	Input V_{CCO}	Input V_{REF}	Board Termination Voltage (V_{TT})
LVTTL	3.3	3.3	N/R(3)	N/R
LVCMOS33	3.3	3.3	N/R	N/R
LVCMOS25	2.5	2.5	N/R	N/R
LVCMOS18	1.8	1.8	N/R	N/R
LVCMOS15	1.5	1.5	N/R	N/R
PCI33_3	3.3	3.3	N/R	N/R
PCI66_3	3.3	3.3	N/R	N/R
PCI-X	3.3	3.3	N/R	N/R
GTL	Note (1)	Note (1)	0.8	1.2
GTLP	Note (1)	Note (1)	1.0	1.5
HSTL_I	1.5	N/R	0.75	0.75
HSTL_II	1.5	N/R	0.75	0.75
HSTL_III	1.5	N/R	0.9	1.5
HSTL_IV	1.5	N/R	0.9	1.5
HSTL_I_18	1.8	N/R	0.9	0.9
HSTL_II_18	1.8	N/R	0.9	0.9
HSTL_III _18	1.8	N/R	1.1	1.8
HSTL_IV_18	1.8	N/R	1.1	1.8
SSTL18_I(2)	1.8	N/R	0.9	0.9
SSTL18_II	1.8	N/R	0.9	0.9
SSTL2_I	2.5	N/R	1.25	1.25
SSTL2_II	2.5	N/R	1.25	1.25
SSTL3_I	3.3	N/R	1.5	1.5
SSTL3_II	3.3	N/R	1.5	1.5
AGP-2X/AGP	3.3	N/R	1.32	N/R

Notes:
1. V_{CCO} of GTL or GTLP should not be lower than the termination voltage or the voltage seen at the I/O pad. Example: If the pin High level is 1.5V, connect V_{CCO} to 1.5V.
2. SSTL18_I is not a JEDEC-supported standard.
3. N/R = no requirement.

Digitally Controlled Impedance (DCI)

Today's chip output signals with fast edge rates require termination to prevent reflections and maintain signal integrity. High pin count packages (especially ball grid arrays) can not accommodate external termination resistors.

Virtex-II XCITE DCI provides controlled impedance drivers and on-chip termination for single-ended and differential I/Os. This eliminates the need for external resistors, and improves signal integrity. The DCI feature can be used on any IOB by selecting one of the DCI I/O standards.

When applied to inputs, DCI provides input parallel termination. When applied to outputs, DCI provides controlled impedance drivers (series termination) or output parallel termination.

DCI operates independently on each I/O bank. When a DCI I/O standard is used in a particular I/O bank, external reference resistors must be connected to two dual-function pins on the bank. These resistors, voltage reference of N transistor (VRN) and the voltage reference of P transistor (VRP) are shown in Figure 9.

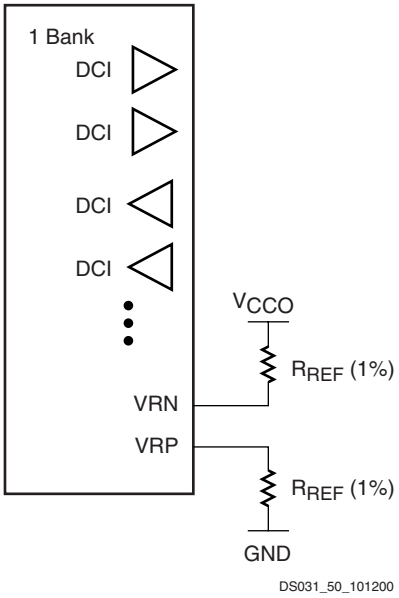

Figure 9: **DCI in a Virtex-II Bank**

When used with a terminated I/O standard, the value of resistors are specified by the standard (typically 50Ω). When used with a controlled impedance driver, the resistors set the output impedance of the driver within the specified range (25Ω to 100Ω). For all series and parallel terminations listed in Table 6 and Table 7, the reference resistors must have the same value for any given bank. One percent resistors are recommended.

The DCI system adjusts the I/O impedance to match the two external reference resistors, or half of the reference resistors, and compensates for impedance changes due to voltage and/or temperature fluctuations. The adjustment is done by turning parallel transistors in the IOB on or off.

Controlled Impedance Drivers (Series Term.)

DCI can be used to provide a buffer with a controlled output impedance. It is desirable for this output impedance to match the transmission line impedance (Z_0). Virtex-II input buffers also support LVDCI and LVDCI_DV2 I/O standards.

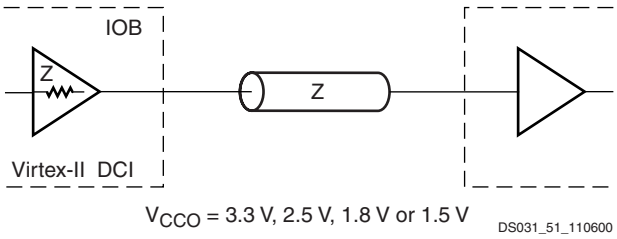

Figure 10: **Internal Series Termination**

Table 6: **SelectI/O-Ultra Controlled Impedance Buffers**

V_{CCO}	DCI	DCI Half Impedance
3.3 V	LVDCI_33	LVDCI_DV2_33
2.5 V	LVDCI_25	LVDCI_DV2_25
1.8 V	LVDCI_18	LVDCI_DV2_18
1.5 V	LVDCI_15	LVDCI_DV2_15

Controlled Impedance Drivers (Parallel)

DCI also provides on-chip termination for SSTL3, SSTL2, HSTL (Class I, II, III, or IV), and GTL/GTLP receivers or transmitters on bidirectional lines.

Table 7 and Table 8 list the on-chip parallel terminations available in Virtex-II devices. V_{CCO} must be set according to Table 3. Note that there is a V_{CCO} requirement for GTL_DCI and GTLP_DCI, due to the on-chip termination resistor.

Table 7: **SelectI/O-Ultra Buffers With On-Chip Parallel Termination**

I/O Standard Description	IOSTANDARD Attribute	
	External Termination	On-Chip Termination
SSTL3 Class I	SSTL3_I	SSTL3_I_DCI(1)
SSTL3 Class II	SSTL3_II	SSTL3_II_DCI(1)
SSTL2 Class I	SSTL2_I	SSTL2_I_DCI(1)
SSTL2 Class II	SSTL2_II	SSTL2_II_DCI(1)
HSTL Class I	HSTL_I	HSTL_I_DCI
HSTL Class II	HSTL_II	HSTL_II_DCI
HSTL Class III	HSTL_III	HSTL_III_DCI
HSTL Class IV	HSTL_IV	HSTL_IV_DCI
GTL	GTL	GTL_DCI
GTLP	GTLP	GTLP_DCI

Notes:
1. SSTL-compatible

Figure 18, Figure 19, and Figure 20 illustrate various example configurations.

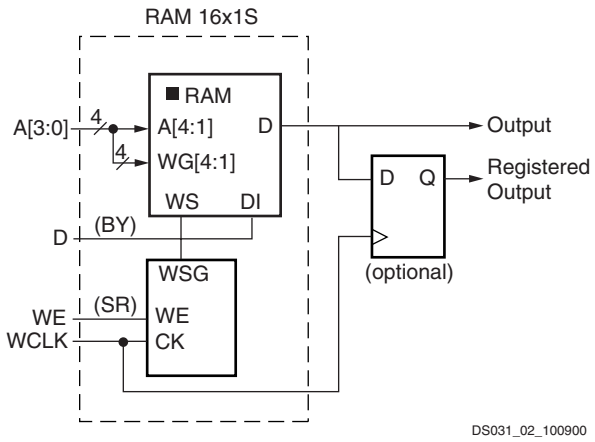

Figure 18: **Distributed SelectRAM (RAM16x1S)**

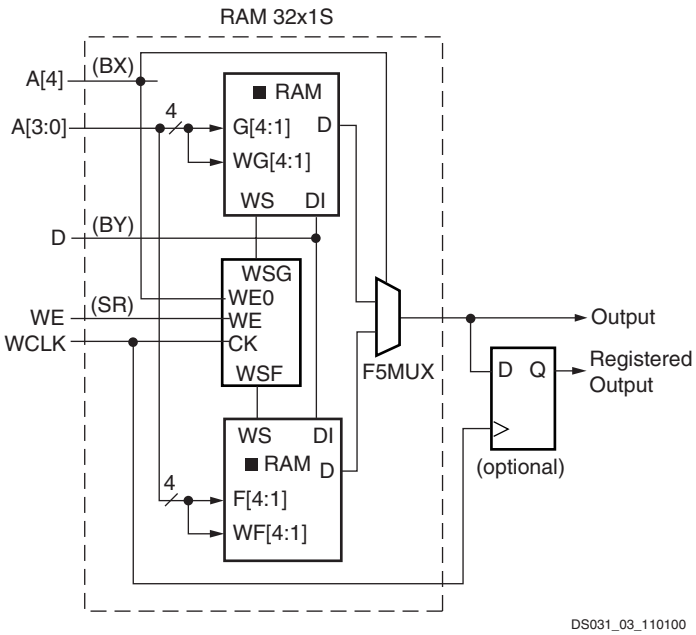

Figure 19: **Single-Port Distributed SelectRAM (RAM32x1S)**

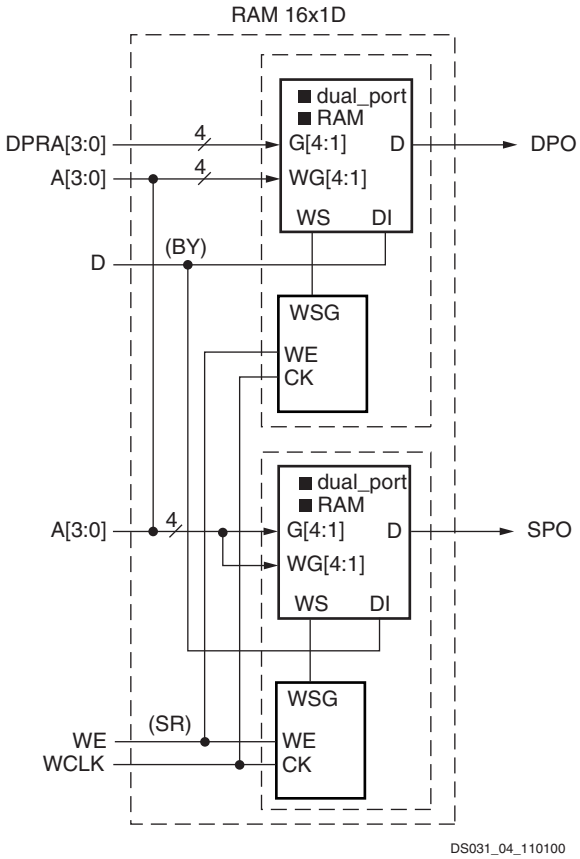

Figure 20: **Dual-Port Distributed SelectRAM (RAM16x1D)**

Similar to the RAM configuration, each function generator (LUT) can implement a 16 x 1-bit ROM. Five configurations are available: ROM16x1, ROM32x1, ROM64x1, ROM128x1, and ROM256x1. The ROM elements are cascadable to implement wider or/and deeper ROM. ROM contents are loaded at configuration. Table 10 shows the number of LUTs occupied by each configuration.

Table 10: **ROM Configuration**

ROM	Number of LUTs
16 x 1	1
32 x 1	2
64 x 1	4
128 x 1	8 (1 CLB)
256 x 1	16 (2 CLBs)

Table 17: **IOB Output Switching Characteristics Standard Adjustments *(Continued)***

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
LVCMOS, 2.5V, Fast, 16 mA	LVCMOS25_F16	$T_{OLVCMOS25\_F16}$	–0.18	–0.19	–0.21	ns
LVCMOS, 2.5V, Fast, 24 mA	LVCMOS25_F24	$T_{OLVCMOS25\_F24}$	–0.35	–0.36	–0.40	ns
LVCMOS, 1.8V, Slow, 2 mA	LVCMOS18_S2	$T_{OLVCMOS18\_S2}$	15.62	16.10	17.71	ns
LVCMOS, 1.8V, Slow, 4 mA	LVCMOS18_S4	$T_{OLVCMOS18\_S4}$	10.20	10.51	11.57	ns
LVCMOS, 1.8V, Slow, 6 mA	LVCMOS18_S6	$T_{OLVCMOS18\_S6}$	7.52	7.75	8.53	ns
LVCMOS, 1.8V, Slow, 8 mA	LVCMOS18_S8	$T_{OLVCMOS18\_S8}$	6.87	7.08	7.78	ns
LVCMOS, 1.8V, Slow, 12 mA	LVCMOS18_S12	$T_{OLVCMOS18\_S12}$	5.54	5.71	6.28	ns
LVCMOS, 1.8V, Slow, 16 mA	LVCMOS18_S16	$T_{OLVCMOS18\_S16}$	5.31	5.47	6.02	ns
LVCMOS, 1.8V, Fast, 2 mA	LVCMOS18_F2	$T_{OLVCMOS18\_F2}$	5.55	5.72	6.30	ns
LVCMOS, 1.8V, Fast, 4 mA	LVCMOS18_F4	$T_{OLVCMOS18\_F4}$	1.89	1.95	2.15	ns
LVCMOS, 1.8V, Fast, 6 mA	LVCMOS18_F6	$T_{OLVCMOS18\_F6}$	0.83	0.85	0.94	ns
LVCMOS, 1.8V, Fast, 8 mA	LVCMOS18_F8	$T_{OLVCMOS18\_F8}$	0.70	0.72	0.80	ns
LVCMOS, 1.8V, Fast, 12 mA	LVCMOS18_F12	$T_{OLVCMOS18\_F12}$	0.26	0.27	0.30	ns
LVCMOS, 1.8V, Fast, 16 mA	LVCMOS18_F16	$T_{OLVCMOS18\_F16}$	0.23	0.23	0.26	ns
LVCMOS, 1.5V, Slow, 2 mA	LVCMOS15_S2	$T_{OLVCMOS15\_S2}$	18.96	19.55	21.50	ns
LVCMOS, 1.5V, Slow, 4 mA	LVCMOS15_S4	$T_{OLVCMOS15\_S4}$	12.77	13.17	14.48	ns
LVCMOS, 1.5V, Slow, 6 mA	LVCMOS15_S6	$T_{OLVCMOS15\_S6}$	12.05	12.42	13.66	ns
LVCMOS, 1.5V, Slow, 8 mA	LVCMOS15_S8	$T_{OLVCMOS15\_S8}$	9.75	10.06	11.06	ns
LVCMOS, 1.5V, Slow, 12 mA	LVCMOS15_S12	$T_{OLVCMOS15\_S12}$	9.04	9.32	10.25	ns
LVCMOS, 1.5V, Slow, 16 mA	LVCMOS15_S16	$T_{OLVCMOS15\_S16}$	8.21	8.46	9.31	ns
LVCMOS, 1.5V, Fast, 2 mA	LVCMOS15_F2	$T_{OLVCMOS15\_F2}$	5.09	5.25	5.78	ns
LVCMOS, 1.5V, Fast, 4 mA	LVCMOS15_F4	$T_{OLVCMOS15\_F4}$	2.01	2.07	2.27	ns
LVCMOS, 1.5V, Fast, 6 mA	LVCMOS15_F6	$T_{OLVCMOS15\_F6}$	1.46	1.51	1.66	ns
LVCMOS, 1.5V, Fast, 8 mA	LVCMOS15_F8	$T_{OLVCMOS15\_F8}$	0.93	0.96	1.05	ns
LVCMOS, 1.5V, Fast, 12 mA	LVCMOS15_F12	$T_{OLVCMOS15\_F12}$	0.74	0.77	0.84	ns
LVCMOS, 1.5V, Fast, 16 mA	LVCMOS15_F16	$T_{OLVCMOS15\_F16}$	0.67	0.69	0.75	ns
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	T_{OLVDS_25}	–0.31	–0.32	–0.36	ns
LVDS, 3.3V	LVDS_33	T_{OLVDS_33}	–0.25	–0.26	–0.29	ns
LVDSEXT (LVDS Extended Mode), 2.5V	LVDSEXT_25	$T_{OLVDSEXT\_25}$	–0.18	–0.19	–0.21	ns
LVDSEXT, 3.3V	LVDSEXT_33	$T_{OLVDSEXT\_33}$	–0.17	–0.18	–0.19	ns
ULVDS (Ultra LVDS), 2.5V	ULVDS_25	T_{OULVDS_25}	–0.20	–0.21	–0.23	ns
BLVDS (Bus LVDS), 2.5V	BLVDS_25	T_{OBLVDS_25}	0.67	0.69	0.76	ns
LDT (HyperTransport), 2.5V	LDT_25	T_{OLDT_25}	–0.20	–0.21	–0.23	ns
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	$T_{OLVPECL\_33}$	0.29	0.30	0.33	ns
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3	T_{OPCI33_3}	1.15	1.19	1.31	ns
PCI, 66 MHz, 3.3V	PCI66_3	T_{OPCI66_3}	–0.01	–0.01	–0.01	ns
PCI-X, 133 MHz, 3.3V	PCIX	T_{OPCIX}	–0.01	–0.01	–0.01	ns
GTL (Gunning Transceiver Logic)	GTL	T_{OGTL}	–0.31	–0.32	–0.36	ns
GTL Plus	GTLP	T_{OGTLP}	–0.17	–0.18	–0.20	ns
HSTL (High-Speed Transceiver Logic), Class I	HSTL_I	T_{OHSTL_I}	0.26	0.27	0.29	ns
HSTL, Class II	HSTL_II	T_{OHSTL_II}	–0.15	–0.16	–0.17	ns
HSTL, Class III	HSTL_III	T_{OHSTL_III}	–0.17	–0.17	–0.19	ns
HSTL, Class IV	HSTL_IV	T_{OHSTL_IV}	–0.40	–0.41	–0.45	ns
HSTL, Class I, 1.8V	HSTL_I_18	$T_{OHSTL\_I\_18}$	0.03	0.03	0.04	ns

Enhanced Multiplier Switching Characteristics

Table 26 and Table 27 provide timing information for enhanced Virtex-II multiplier blocks, available in stepping revisions of Virtex-II devices. For more information on stepping revisions, availability, and ordering instructions, see your local sales representative.

Table 26: **Enhanced Multiplier Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Propagation Delay to Output Pin					
Input to Pin 35	T_{MULT1_P35}	4.66	5.14	5.91	ns, Max
Input to Pin 34	T_{MULT1_P34}	4.57	5.03	5.79	ns, Max
Input to Pin 33	T_{MULT1_P33}	4.47	4.93	5.66	ns, Max
Input to Pin 32	T_{MULT1_P32}	4.37	4.82	5.54	ns, Max
Input to Pin 31	T_{MULT1_P31}	4.28	4.71	5.42	ns, Max
Input to Pin 30	T_{MULT1_P30}	4.18	4.61	5.29	ns, Max
Input to Pin 29	T_{MULT1_P29}	4.08	4.50	5.17	ns, Max
Input to Pin 28	T_{MULT1_P28}	3.99	4.39	5.05	ns, Max
Input to Pin 27	T_{MULT1_P27}	3.89	4.28	4.92	ns, Max
Input to Pin 26	T_{MULT1_P26}	3.79	4.18	4.80	ns, Max
Input to Pin 25	T_{MULT1_P25}	3.69	4.07	4.68	ns, Max
Input to Pin 24	T_{MULT1_P24}	3.60	3.96	4.56	ns, Max
Input to Pin 23	T_{MULT1_P23}	3.50	3.86	4.43	ns, Max
Input to Pin 22	T_{MULT1_P22}	3.40	3.75	4.31	ns, Max
Input to Pin 21	T_{MULT1_P21}	3.31	3.64	4.19	ns, Max
Input to Pin 20	T_{MULT1_P20}	3.21	3.54	4.06	ns, Max
Input to Pin 19	T_{MULT1_P19}	3.11	3.43	3.94	ns, Max
Input to Pin 18	T_{MULT1_P18}	3.02	3.32	3.82	ns, Max
Input to Pin 17	T_{MULT1_P17}	2.92	3.21	3.69	ns, Max
Input to Pin 16	T_{MULT1_P16}	2.82	3.11	3.57	ns, Max
Input to Pin 15	T_{MULT1_P15}	2.72	3.00	3.45	ns, Max
Input to Pin 14	T_{MULT1_P14}	2.63	2.89	3.33	ns, Max
Input to Pin 13	T_{MULT1_P13}	2.53	2.79	3.20	ns, Max
Input to Pin 12	T_{MULT1_P12}	2.43	2.68	3.08	ns, Max
Input to Pin 11	T_{MULT1_P11}	2.34	2.57	2.96	ns, Max
Input to Pin 10	T_{MULT1_P10}	2.24	2.47	2.83	ns, Max
Input to Pin 9	T_{MULT1_P9}	2.14	2.36	2.71	ns, Max
Input to Pin 8	T_{MULT1_P8}	2.05	2.25	2.59	ns, Max
Input to Pin 7	T_{MULT1_P7}	1.95	2.14	2.46	ns, Max
Input to Pin 6	T_{MULT1_P6}	1.85	2.04	2.34	ns, Max
Input to Pin 5	T_{MULT1_P5}	1.75	1.93	2.22	ns, Max
Input to Pin 4	T_{MULT1_P4}	1.66	1.82	2.10	ns, Max
Input to Pin 3	T_{MULT1_P3}	1.56	1.72	1.97	ns, Max
Input to Pin 2	T_{MULT1_P2}	1.46	1.61	1.85	ns, Max
Input to Pin 1	T_{MULT1_P1}	1.37	1.50	1.73	ns, Max
Input to Pin 0	T_{MULT1_P0}	1.27	1.40	1.60	ns, Max

Input Clock Tolerances

Table 39: **Input Clock Tolerances**

Description	Symbol	Constraints F_{CLKIN}	Speed Grade						Units
			-6		-5		-4		
			Min	Max	Min	Max	Min	Max	
Input Clock Low/High Pulse Width									
PSCLK	PSCLK_PULSE	< 1MHz	25.00		25.00		25.00		ns
PSCLK and CLKIN(3)	PSCLK_PULSE and CLKIN_PULSE	1 – 10 MHz	25.00		25.00		25.00		ns
		10 – 25 MHz	10.00		10.00		10.00		ns
		25 – 50 MHz	5.00		5.00		5.00		ns
		50 – 100 MHz	3.00		3.00		3.00		ns
		100 – 150 MHz	2.40		2.40		2.40		ns
		150 – 200 MHz	2.00		2.00		2.00		ns
		200 – 250 MHz	1.80		1.80		1.80		ns
		250 – 300 MHz	1.50		1.50		1.50		ns
		300 – 350 MHz	1.30		1.30		1.30		ns
		350 – 400 MHz	1.15		1.15		1.15		ns
		> 400 MHz	1.05		1.05		1.05		ns
Input Clock Cycle-Cycle Jitter (Low Frequency Mode)									
CLKIN (using DLL outputs)(1)	CLKIN_CYC_JITT_DLL_LF			±300		±300		±300	ps
CLKIN (using CLKFX outputs)(2)	CLKIN_CYC_JITT_FX_LF			±300		±300		±300	ps
Input Clock Cycle-Cycle Jitter (High Frequency Mode)									
CLKIN (using DLL outputs)(1)	CLKIN_CYC_JITT_DLL_HF			±150		±150		±150	ps
CLKIN (using CLKFX outputs)(2)	CLKIN_CYC_JITT_FX_HF			±150		±150		±150	ps
Input Clock Period Jitter (Low Frequency Mode)									
CLKIN (using DLL outputs)(1)	CLKIN_PER_JITT_DLL_LF			±1		±1		±1	ns
CLKIN (using CLKFX outputs)(2)	CLKIN_PER_JITT_FX_LF			±1		±1		±1	ns
Input Clock Period Jitter (High Frequency Mode)									
CLKIN (using DLL outputs)(1)	CLKIN_PER_JITT_DLL_HF			±1		±1		±1	ns
CLKIN (using CLKFX outputs)(2)	CLKIN_PER_JITT_FX_HF			±1		±1		±1	ns
Feedback Clock Path Delay Variation									
CLKFB off-chip feedback	CLKFB_DELAY_VAR_EXT			±1		±1		±1	ns

Notes:
1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. If both DLL and CLKFX outputs are used, follow the more restrictive specification.
3. If DCM phase shift feature is used and CLKIN frequency > 200 Mhz, CLKIN duty cycle must be within ±5% (45/55 to 55/45).

Miscellaneous Timing Parameters

Table 42: **Miscellaneous Timing Parameters**

Description	Symbol	Constraints F_{CLKIN}	Speed Grade			Units
			-6	-5	-4	
Time Required to Achieve LOCK						
Using DLL outputs(1)	LOCK_DLL					
	LOCK_DLL_60	> 60MHz	20.0	20.0	20.0	µs
	LOCK_DLL_50_60	50 - 60 MHz	25.0	25.0	25.0	µs
	LOCK_DLL_40_50	40 - 50 MHz	50.0	50.0	50.0	µs
	LOCK_DLL_30_40	30 - 40 MHz	90.0	90.0	90.0	µs
	LOCK_DLL_24_30	24 - 30 MHz	120.0	120.0	120.0	µs
Using CLKFX outputs	LOCK_FX_MIN		10.0	10.0	10.0	ms
	LOCK_FX_MAX		10.0	10.0	10.0	ms
Additional lock time with fine-phase shifting	LOCK_DLL_FINE_SHIFT		50.0	50.0	50.0	µs
Fine-Phase Shifting						
Absolute shifting range	FINE_SHIFT_RANGE		10.0	10.0	10.0	ns
Delay Lines						
Tap delay resolution	DCM_TAP_MIN		30.0	30.0	30.0	ps
	DCM_TAP_MAX		60.0	60.0	60.0	ps

Notes:
1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. Specification also applies to PSCLK.

Frequency Synthesis

Table 43: **Frequency Synthesis**

Attribute	Min	Max
CLKFX_MULTIPLY	2	32
CLKFX_DIVIDE	1	32

Parameter Cross Reference

Table 44: **Parameter Cross Reference**

Libraries Guide	Data Sheet
DLL_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_{1X|2X|DV}_LF
DFS_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_FX_LF
DLL_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_DLL_LF
DFS_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_FX_LF
DLL_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_{1X|DV}_HF
DFS_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_FX_HF
DLL_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_DLL_HF
DFS_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_FX_HF

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
0	IO_L69P_0/VREF_0	B9	NC	
0	IO_L70N_0	F10	NC	
0	IO_L70P_0	E10	NC	
0	IO_L72N_0	A10	NC	
0	IO_L72P_0	A11	NC	
0	IO_L73N_0	C10	NC	NC
0	IO_L73P_0	B10	NC	NC
0	IO_L91N_0/VREF_0	D11		
0	IO_L91P_0	C11		
0	IO_L92N_0	G11		
0	IO_L92P_0	E11		
0	IO_L93N_0	C12		
0	IO_L93P_0	B12		
0	IO_L94N_0/VREF_0	E12		
0	IO_L94P_0	D12		
0	IO_L95N_0/GCLK7P	G12		
0	IO_L95P_0/GCLK6S	F12		
0	IO_L96N_0/GCLK5P	H11		
0	IO_L96P_0/GCLK4S	H12		
1	IO_L96N_1/GCLK3P	A13		
1	IO_L96P_1/GCLK2S	A14		
1	IO_L95N_1/GCLK1P	B13		
1	IO_L95P_1/GCLK0S	C13		
1	IO_L94N_1	D13		
1	IO_L94P_1/VREF_1	E13		
1	IO_L93N_1	F13		
1	IO_L93P_1	G13		
1	IO_L92N_1	H13		
1	IO_L92P_1	H14		
1	IO_L91N_1	C14		
1	IO_L91P_1/VREF_1	D14		
1	IO_L73N_1	E14	NC	NC
1	IO_L73P_1	G14	NC	NC
1	IO_L72N_1	A15	NC	
1	IO_L72P_1	A16	NC	

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
1	VCCO_1	B14		
2	VCCO_2	M16		
2	VCCO_2	L23		
2	VCCO_2	L19		
2	VCCO_2	L16		
2	VCCO_2	K16		
2	VCCO_2	F22		
3	VCCO_3	W22		
3	VCCO_3	R16		
3	VCCO_3	P23		
3	VCCO_3	P19		
3	VCCO_3	P16		
3	VCCO_3	N16		
4	VCCO_4	AC14		
4	VCCO_4	AB19		
4	VCCO_4	W14		
4	VCCO_4	T15		
4	VCCO_4	T14		
4	VCCO_4	T13		
5	VCCO_5	AC11		
5	VCCO_5	AB6		
5	VCCO_5	W11		
5	VCCO_5	T12		
5	VCCO_5	T11		
5	VCCO_5	T10		
6	VCCO_6	W3		
6	VCCO_6	R9		
6	VCCO_6	P9		
6	VCCO_6	P6		
6	VCCO_6	P2		
6	VCCO_6	N9		
7	VCCO_7	M9		
7	VCCO_7	L9		
7	VCCO_7	L6		
7	VCCO_7	L2		
7	VCCO_7	K9		

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
NA	GND	T12
NA	GND	R16
NA	GND	R15
NA	GND	R14
NA	GND	R13
NA	GND	R12
NA	GND	P27
NA	GND	P24
NA	GND	P19
NA	GND	P16
NA	GND	P15
NA	GND	P14
NA	GND	P13
NA	GND	P12
NA	GND	P9
NA	GND	P4
NA	GND	P1
NA	GND	N16
NA	GND	N15
NA	GND	N14
NA	GND	N13
NA	GND	N12
NA	GND	M16
NA	GND	M15
NA	GND	M14
NA	GND	M13
NA	GND	M12
NA	GND	L23
NA	GND	L5
NA	GND	J14
NA	GND	H26
NA	GND	H20
NA	GND	H8
NA	GND	H2
NA	GND	G21
NA	GND	G7

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
3	IO_L73P_3	W4	NC	NC
3	IO_L72N_3	W7	NC	
3	IO_L72P_3	V7	NC	
3	IO_L71N_3	V5	NC	
3	IO_L71P_3	W6	NC	
3	IO_L70N_3	W3	NC	
3	IO_L70P_3	Y3	NC	
3	IO_L69N_3/VREF_3	V8	NC	
3	IO_L69P_3	W8	NC	
3	IO_L68N_3	AA1	NC	
3	IO_L68P_3	AB1	NC	
3	IO_L67N_3	Y4	NC	
3	IO_L67P_3	AA4	NC	
3	IO_L54N_3	AA6		
3	IO_L54P_3	Y6		
3	IO_L53N_3	AA2		
3	IO_L53P_3	AB2		
3	IO_L52N_3	Y5		
3	IO_L52P_3	AA5		
3	IO_L51N_3/VREF_3	Y8		
3	IO_L51P_3	AA8		
3	IO_L50N_3	AC2		
3	IO_L50P_3	AD2		
3	IO_L49N_3	Y7		
3	IO_L49P_3	AA7		
3	IO_L48N_3	AC6		
3	IO_L48P_3	AB6		
3	IO_L47N_3	AD1		
3	IO_L47P_3	AE1		
3	IO_L46N_3	AB3		
3	IO_L46P_3	AC3		
3	IO_L45N_3/VREF_3	AB7		
3	IO_L45P_3	AC7		
3	IO_L44N_3	AB4		
3	IO_L44P_3	AC4		
3	IO_L43N_3	AB5		
3	IO_L43P_3	AC5		

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
7	IO_L95N_7	R24		
7	IO_L94P_7	R29		
7	IO_L94N_7	T29		
7	IO_L93P_7/VREF_7	R27		
7	IO_L93N_7	P27		
7	IO_L92P_7	R23		
7	IO_L92N_7	P23		
7	IO_L91P_7	N30		
7	IO_L91N_7	P30		
7	IO_L78P_7	P26	NC	NC
7	IO_L78N_7	R26	NC	NC
7	IO_L77P_7	R22	NC	NC
7	IO_L77N_7	P22	NC	NC
7	IO_L76P_7	N29	NC	NC
7	IO_L76N_7	P29	NC	NC
7	IO_L75P_7/VREF_7	N27	NC	NC
7	IO_L75N_7	N26	NC	NC
7	IO_L74P_7	P25	NC	NC
7	IO_L74N_7	N25	NC	NC
7	IO_L73P_7	L30	NC	NC
7	IO_L73N_7	M30	NC	NC
7	IO_L72P_7	L28	NC	
7	IO_L72N_7	M28	NC	
7	IO_L71P_7	N24	NC	
7	IO_L71N_7	M24	NC	
7	IO_L70P_7	L29	NC	
7	IO_L70N_7	M29	NC	
7	IO_L69P_7/VREF_7	M27	NC	
7	IO_L69N_7	L27	NC	
7	IO_L68P_7	N23	NC	
7	IO_L68N_7	M23	NC	
7	IO_L67P_7	J30	NC	
7	IO_L67N_7	K30	NC	
7	IO_L54P_7	K26		
7	IO_L54N_7	L26		
7	IO_L53P_7	M25		
7	IO_L53N_7	L25		

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
4	IO_L20N_4	AJ10	
4	IO_L20P_4	AJ9	
4	IO_L21N_4	AH9	
4	IO_L21P_4/VREF_4	AH10	
4	IO_L22N_4	AN5	
4	IO_L22P_4	AN4	
4	IO_L23N_4	AE12	
4	IO_L23P_4	AE13	
4	IO_L24N_4	AM9	
4	IO_L24P_4	AL8	
4	IO_L25N_4	AP5	
4	IO_L25P_4	AP4	
4	IO_L26N_4	AG11	
4	IO_L26P_4	AG12	
4	IO_L27N_4	AN7	
4	IO_L27P_4/VREF_4	AN6	
4	IO_L28N_4	AL10	
4	IO_L28P_4	AL9	
4	IO_L29N_4	AF12	
4	IO_L29P_4	AF13	
4	IO_L30N_4	AK10	
4	IO_L30P_4	AK11	
4	IO_L49N_4	AP7	
4	IO_L49P_4	AP6	
4	IO_L50N_4	AH13	
4	IO_L50P_4	AH12	
4	IO_L51N_4	AJ11	
4	IO_L51P_4/VREF_4	AJ12	
4	IO_L52N_4	AP9	
4	IO_L52P_4	AN8	
4	IO_L53N_4	AG13	
4	IO_L53P_4	AG14	
4	IO_L54N_4	AM11	
4	IO_L54P_4	AL11	
4	IO_L60N_4	AN10	NC
4	IO_L60P_4	AN9	NC

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
5	VCCO_5	AP19	
5	VCCO_5	AL28	
5	VCCO_5	AK20	
5	VCCO_5	AD23	
5	VCCO_5	AD22	
5	VCCO_5	AD21	
5	VCCO_5	AD20	
5	VCCO_5	AC22	
5	VCCO_5	AC21	
5	VCCO_5	AC20	
5	VCCO_5	AC19	
5	VCCO_5	AC18	
6	VCCO_6	AH31	
6	VCCO_6	AE34	
6	VCCO_6	AC24	
6	VCCO_6	AB24	
6	VCCO_6	AB23	
6	VCCO_6	AA24	
6	VCCO_6	AA23	
6	VCCO_6	Y30	
6	VCCO_6	Y24	
6	VCCO_6	Y23	
6	VCCO_6	W34	
6	VCCO_6	W23	
6	VCCO_6	V23	
7	VCCO_7	U23	
7	VCCO_7	T34	
7	VCCO_7	T23	
7	VCCO_7	R30	
7	VCCO_7	R24	
7	VCCO_7	R23	
7	VCCO_7	P24	
7	VCCO_7	P23	
7	VCCO_7	N24	
7	VCCO_7	N23	
7	VCCO_7	M24	

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
7	VCCO_7	K34	
7	VCCO_7	G31	
NA	CCLK	AH8	
NA	PROG_B	D30	
NA	DONE	AJ7	
NA	M0	AH27	
NA	M1	AJ28	
NA	M2	AK29	
NA	HSWAP_EN	E29	
NA	TCK	F7	
NA	TDI	C31	
NA	TDO	D5	
NA	TMS	E6	
NA	PWRDWN_B	AK6	
NA	DXN	F28	
NA	DXP	G27	
NA	VBATT	C4	
NA	RSVD	G8	
NA	VCCAUX	AM30	
NA	VCCAUX	AM18	
NA	VCCAUX	AM5	
NA	VCCAUX	V3	
NA	VCCAUX	U32	
NA	VCCAUX	C30	
NA	VCCAUX	C17	
NA	VCCAUX	C5	
NA	VCCINT	AD24	
NA	VCCINT	AD11	
NA	VCCINT	AC23	
NA	VCCINT	AC12	
NA	VCCINT	AB22	
NA	VCCINT	AB21	
NA	VCCINT	AB20	
NA	VCCINT	AB19	
NA	VCCINT	AB18	

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	VCCINT	AB17	
NA	VCCINT	AB16	
NA	VCCINT	AB15	
NA	VCCINT	AB14	
NA	VCCINT	AB13	
NA	VCCINT	AA22	
NA	VCCINT	AA13	
NA	VCCINT	Y22	
NA	VCCINT	Y13	
NA	VCCINT	W22	
NA	VCCINT	W13	
NA	VCCINT	V22	
NA	VCCINT	V13	
NA	VCCINT	U22	
NA	VCCINT	U13	
NA	VCCINT	T22	
NA	VCCINT	T13	
NA	VCCINT	R22	
NA	VCCINT	R13	
NA	VCCINT	P22	
NA	VCCINT	P13	
NA	VCCINT	N22	
NA	VCCINT	N21	
NA	VCCINT	N20	
NA	VCCINT	N19	
NA	VCCINT	N18	
NA	VCCINT	N17	
NA	VCCINT	N16	
NA	VCCINT	N15	
NA	VCCINT	N14	
NA	VCCINT	N13	
NA	VCCINT	M23	
NA	VCCINT	M12	
NA	VCCINT	L24	
NA	VCCINT	L11	

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
0	IO_L76P_0	C24		
0	IO_L77N_0	K22		
0	IO_L77P_0	K21		
0	IO_L78N_0	E22		
0	IO_L78P_0	E23		
0	IO_L79N_0	B23		
0	IO_L79P_0	B24		
0	IO_L80N_0	J22		
0	IO_L80P_0	J21		
0	IO_L81N_0	G21		
0	IO_L81P_0/VREF_0	G22		
0	IO_L82N_0	A23		
0	IO_L82P_0	A24		
0	IO_L83N_0	H22		
0	IO_L83P_0	H21		
0	IO_L84N_0	F21		
0	IO_L84P_0	F22		
0	IO_L91N_0/VREF_0	B21		
0	IO_L91P_0	B22		
0	IO_L92N_0	L20		
0	IO_L92P_0	M20		
0	IO_L93N_0	E21		
0	IO_L93P_0	D22		
0	IO_L94N_0/VREF_0	A21		
0	IO_L94P_0	A22		
0	IO_L95N_0/GCLK7P	H20		
0	IO_L95P_0/GCLK6S	J20		
0	IO_L96N_0/GCLK5P	C21		
0	IO_L96P_0/GCLK4S	D21		
1	IO_L96N_1/GCLK3P	F19		
1	IO_L96P_1/GCLK2S	F20		
1	IO_L95N_1/GCLK1P	H19		
1	IO_L95P_1/GCLK0S	H18		
1	IO_L94N_1	C19		
1	IO_L94P_1/VREF_1	C20		

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
4	IO_L78N_4	AJ13	
4	IO_L78P_4	AK13	
4	IO_L91N_4/VREF_4	AC15	
4	IO_L91P_4	AC16	
4	IO_L92N_4	AG14	
4	IO_L92P_4	AG15	
4	IO_L93N_4	AK14	
4	IO_L93P_4	AK15	
4	IO_L94N_4/VREF_4	AF16	
4	IO_L94P_4	AG16	
4	IO_L95N_4/GCLK3S	AL14	
4	IO_L95P_4/GCLK2P	AL15	
4	IO_L96N_4/GCLK1S	AH15	
4	IO_L96P_4/GCLK0P	AJ15	
5	IO_L96N_5/GCLK7S	AJ16	
5	IO_L96P_5/GCLK6P	AH17	
5	IO_L95N_5/GCLK5S	AD16	
5	IO_L95P_5/GCLK4P	AD17	
5	IO_L94N_5	AL17	
5	IO_L94P_5/VREF_5	AL18	
5	IO_L93N_5	AG17	
5	IO_L93P_5	AF17	
5	IO_L92N_5	AE17	
5	IO_L92P_5	AE18	
5	IO_L91N_5	AK17	
5	IO_L91P_5/VREF_5	AJ17	
5	IO_L78N_5	AK18	
5	IO_L78P_5	AK19	
5	IO_L77N_5	AC17	
5	IO_L77P_5	AB18	
5	IO_L76N_5	AH18	
5	IO_L76P_5	AH19	
5	IO_L75N_5/VREF_5	AL19	
5	IO_L75P_5	AL20	
5	IO_L74N_5	AC18	
5	IO_L74P_5	AC19	
5	IO_L73N_5	AJ19	

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
5	IO_L73P_5	AJ20	
5	IO_L72N_5	AG18	
5	IO_L72P_5	AG19	
5	IO_L71N_5	AF18	
5	IO_L71P_5	AF19	
5	IO_L70N_5	AK20	
5	IO_L70P_5	AK21	
5	IO_L69N_5/VREF_5	AH20	
5	IO_L69P_5	AH21	
5	IO_L68N_5	AD19	
5	IO_L68P_5	AD20	
5	IO_L67N_5	AL21	
5	IO_L67P_5	AL22	
5	IO_L54N_5	AG20	
5	IO_L54P_5	AG21	
5	IO_L53N_5	AB19	
5	IO_L53P_5	AB20	
5	IO_L52N_5	AJ21	
5	IO_L52P_5	AJ22	
5	IO_L51N_5/VREF_5	AF20	
5	IO_L51P_5	AF21	
5	IO_L50N_5	AE20	
5	IO_L50P_5	AE21	
5	IO_L49N_5	AK22	
5	IO_L49P_5	AK23	
5	IO_L30N_5	AJ23	NC
5	IO_L30P_5	AJ24	NC
5	IO_L29N_5	AC20	NC
5	IO_L29P_5	AC21	NC
5	IO_L28N_5	AL23	NC
5	IO_L28P_5	AL24	NC
5	IO_L27N_5/VREF_5	AL25	NC
5	IO_L27P_5	AL26	NC
5	IO_L26N_5	AD21	NC
5	IO_L26P_5	AD22	NC
5	IO_L25N_5	AH23	NC
5	IO_L25P_5	AH24	NC
5	IO_L24N_5	AG22	